HIGH SPEED I/O PRODUCTS



AMPHENOL COMMERCIAL PRODUCTS

Amphenol

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THE COMPANY

Amphenol is a global provider of interconnect solutions to the designers and manufacturers of worldwide networking systems. With our design creativity and cost effectiveness, Amphenol leads the way in interconnect development for internet equipment, infrastructure, enterprise networks and appliances. Whether industry standard or specific designs are required, Amphenol provides customers with products capable of performing at the leading edge of today's high speed technology. Our expertise in understanding and supporting our customers' various design needs has earned Amphenol a reputation of excellence and quality among the world's leading users of high speed components.

HIGH SPEED CONNECTORS

Amphenol offers a full range of high-speed connectors with data rates ranging from 1 Gbps to 120 Gbps and beyond, meeting our customers' various high speed connector requirements. Products include SFP, ExpressPort™ SFP+, Infinity, VHDCI, XFP, ExpressPort™ XFP+, Mini-SAS, Mini-SAS HD, CXP, QSFP, ExpressPort™ QSFP+ and ExpressPort™ QSFP+ E-Series.

BENEFITS

- Increased platform density for scaling improved performance in a defined physical space
- Servers that can scale I/O and processing power independently
- · Racks of servers that can be managed as one autonomous unit
- Servers that can share I/O resources
- True "plug-and-play" I/O connectivity
- Extensive range of SFP+ / IPF connector and cage solutions to support Fiber Channel, Infiniband, Ethernet and Gigabit technology
- Next generation Expressport[™] connectors provide premium level performance for SFP+, XFP+ and QSFP+ interfaces.
 This technology allows data speeds to reach 14-16 Gbps.





Telephone: (416) 291-4401 Fax: (416) 292-0647 E-Mail: sales@amphenolcanada.com

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ExpressPort™ SFP+ 1xN Cage & Connector







Amphenol's ExpressPort™ SFP+ 1xN Connector, when combined with the ExpressPort™ SFP+ Cages, provides data transfers speeds of up to 14 Gbps. The design of the ExpressPort™ SFP+ Connector minimizes impedance discontinuities and reflections at high data rates, and provides a 10 to 20 dB improvement in Near-End Crosstalk.

Amphenol's unique ExpressPort™ SFP+ cage construction features EMI shielding available in the form of metal spring fingers, or elastomeric gaskets. These cages also eliminate ventilation holes near the front of the cage to prevent potential catch points for the mating module EMI springs. Additional features include light pipes, which can be purchased with cages or separately, heat sinks, and other custom features.

Specification Highlights

The interconnect system is comprised of a cage assembly which is used with 20-position SFP+ connectors complying with SFF-8083. Cages comply with industry standard SFF-8433.

General Characteristics

- RoHS compliant
- Industry standard footprint
- Industry standard EIA-364

Mechanical Characteristics

- Accepts multiple transceivers per INF-8074i and SFF-8431
- Compliant press-fit pins or solder tails (1x1 cages)
- Durability: 250 mating cycles minimum

Electrical Characteristics

- Hot swappable
- Operating voltage: 3.3 V
- Operating current: 0.5 A
- Differential impedance: 100 Ω +/-10 Ω
- DWV: 300 V AC
- Insulation resistance: 1000 M Ω min
- Contact resistance: 70 m Ω max

Options

- EMI shielding
 - Metal spring fingers
 - Conductive elastomeric gasket
- Round light pipe
- Heat sink
- Dust cover

Materials

- Cage
 - Base material: copper alloy
 - · Plating: nickel or tin
 - Light pipe: optical grade polycarbonate
 - Heat sink: aluminum alloy
 - · Heat sink clip: stainless steel
 - Dust cover: thermoplastic
- Connector
 - Contact base material: copper alloy
 - Contact plating: gold on mating area; gold or matte tin on termination
 - Housings: glass reinforced, lead-free solder reflow process compatible thermoplastic, UL94V-0 rated

Temperature Rating

- Operating temperature: -55 °C to +85 °C
- Storage temperature: -55 °C to +105 °C

Configurations (Rows x Ports per row)

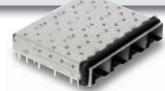
• 1x1 • 1x2 • 1x4 • 1x6

Packaging

- Tape and reel packaging: connector or 1x1 cage
- Tray packaging: cage of all sizes
- · Bulk packaging: dust cover



1x1 SFP+ Cage with Light Pipes and Elastomeric Gasket U77-C1419-2001

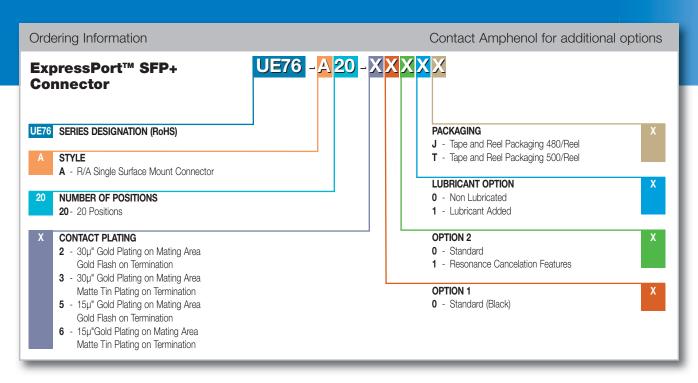


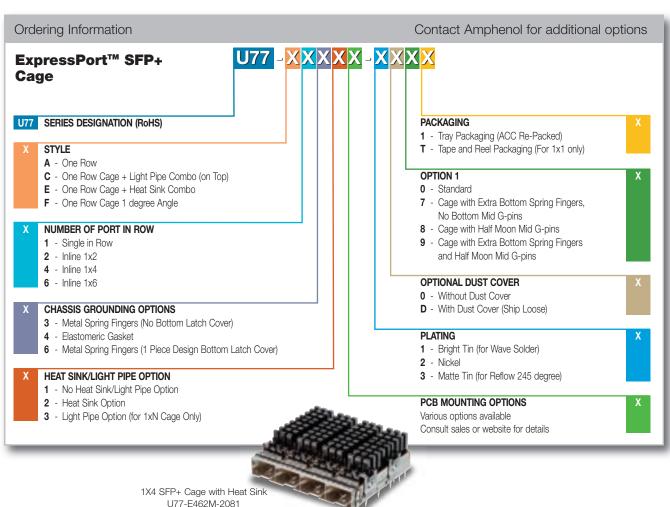
1x4 SFP+ Cage with Elastomeric Gasket U77-A441M-2081



1x6 SFP+ Cage with Light Pipes and Elastomeric Gasket U77-C641M-2081



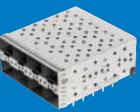




ExpressPort™ SFP+ 2xN Cage & Connector







U86-K4627-10121

Amphenol's ExpressPort™ SFP+ 2xN Combos provide data transfer speeds of up to 14 Gbps per port. ExpressPort™ SFP+ 2xN Combos consist of an integrated stacked connector system and a cage with compliant press-fit pins.

Amphenol's unique ExpressPort™ SFP+ cage construction features EMI shielding available in the form of metal spring fingers or elastomeric gaskets. These cages also eliminate ventilation holes n near the front of the cage to prevent potential catch points for the mating module EMI springs.

Specification Highlights

The interconnect system is comprised of a 2-row stacked, 20-position, 0.8 mm pitch SFP+ connector and cage assembly as one unit with all press-fit construction.

General Characteristics

- RoHS compliant
- Press-fit cage and connector combo for minimum
 1.57 +/-10% mm (0.0625") PCB thickness
- Industry standard EIA-364

Mechanical Characteristics

- Accepts multiple transceivers per INF-8074i
- Card entry slot accepts 1.0 mm thick integrated circuit cards
- Durability: 250 mating cycles minimum

Electrical Characteristics

- Hot swappable
- Operating voltage: 3.3 V
- Operating current: 0.5 A
- Differential impedance: 100 Ω +/- 10 Ω
- DWV: 300 V AC
- Insulation resistance: 1000 M Ω min
- Contact resistance: 70 m Ω max

Packaging

- Tray packaging: cage and connector assembly
- Bulk packaging: dust cover

Configurations (Rows x Ports per row)

• 2x1 • 2x2 • 2x4 • 2x6 • 2x8

Materials

- Cage
 - Base material: copper alloy
 - Plating: nickel or tin
 - Light pipe: optical grade polycarbonate
 - Dust cover: thermoplastic
- Connector
 - Contact base material: copper alloy
 - Contact plating: gold on mating area; tin-lead on termination
 - Housings: glass reinforced, lead-free solder reflow process compatible thermoplastic, UL94V-0 rated

Temperature Rating

- Operating temperature: -55 °C to +85 °C
- Storage temperature: -55 °C to +105 °C

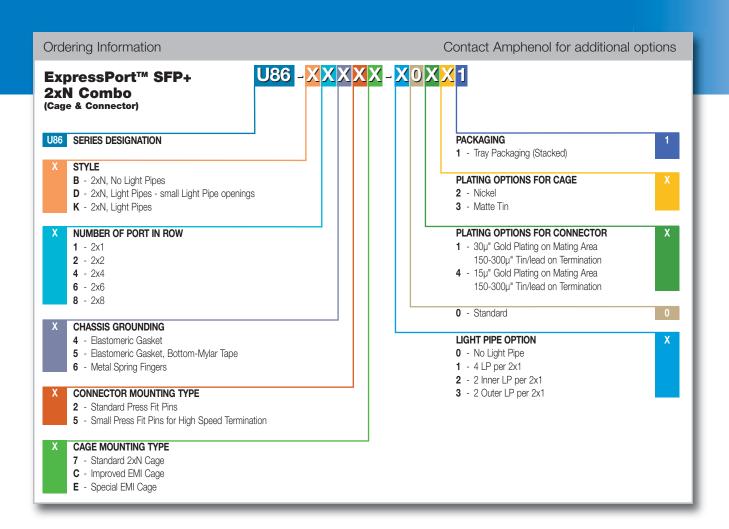
Options

- Dust cover
- Light pipe
 - 4 light pipes per 2x1
 - 2 inner light pipes per 2x1
 - 2 outer light pipes per 2x1
- EMI shielding
 - Metal spring fingers
 - Conductive elastomeric gasket











2x4 SFP+ Combo with Light Pipes and Spring Fingers U86-K4627-30121



2x6 SFP+ Combo with Light Pipes and Elastomeric Gasket U86-K6427-10121



2x8 SFP+ Combo with Light Pipes and Elastomeric Gasket U86-K8427-20121

SFP





Amphenol's SFP interconnect system consists of a 20-position connector enclosed in a metal cage mounted to a host PCB.

Amphenol single port and stacked SFP connectors are rated up to 6 Gbps. They are available in standard RoHS compliant or non-RoHS compliant versions. The cages have a one-piece construction with enhanced transceiver mating tabs available in press-fit version and solder tail version. Longer or shorter pins are available as custom options.

Single Row versions (1xN) consist of SMT connectors used with a separate single row cage (press-fit or solder tail). Stacked versions (2xN) consist of a 2 row cage with integrated 2 row connectors. The entire assembly is press-fit compliant pin.

Specification Highlights

The interconnect system is comprised of a cage assembly which is used with 20-position SFP connectors complying with MSA Agreement INF-8074i.

General Characteristics

- RoHS compliant
- Industry standard footprint
- Industry standard EIA-364

Mechanical Characteristics

- Accepts multiple transceivers per INF-8074i
- Compliant press-fit pins or solder tails (1x1 cages)
- Durability: 250 mating cycles minimum

Electrical Characteristics

- Hot swappable
- Operating voltage: 3.3 V
- Operating current: 0.5 A
- Differential impedance: 100 Ω +/- 10 Ω
- DWV: 300 V AC
- Insulation resistance: 1000 M Ω min
- Contact resistance: 70 m Ω max
- Spring fingers for superior EMI grounding

Packaging

- Tape and reel packaging: connector or 1x1 cage
- Tray packaging: cage of all sizes
- Bulk packaging: dust cover

Materials

- Cage
 - Base material: copper alloy
 - · Plating: nickel or tin
 - Light pipe: optical grade polycarbonate
 - Heat sink: aluminum alloy
 - · Heat sink clip: stainless steel
 - Dust cover: thermoplastic
 - EMI ground tabs: stainless steel
- Connector
 - Contact base material: copper alloy
 - Contact plating: gold on mating area; gold or matte tin on termination
 - Housings: glass reinforced, lead-free solder reflow process compatible thermoplastic, UL94V-0 rated

Temperature Rating

- Operating temperature: -55 °C to +85 °C
- Storage temperature: -55 °C to +105 °C

Configurations (Rows x Ports per row)

• 1x1 • 1x2 • 1x4 • 1x6 • 2x1 • 2x2 • 2x4 • 2x6

Options

- Light pipes
- Heat sink (standard fin for final cage combo)
- Enhanced EMI performance cage
- Dust cover



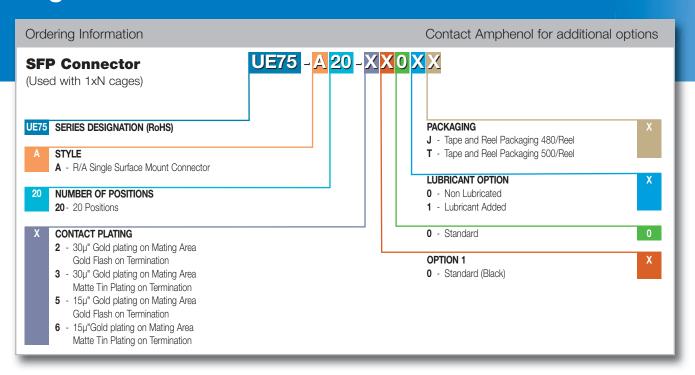
1x4 SFP cage with heat sinks U77-E4124-2041 2x2 SFP Combo U78-B2127-00121

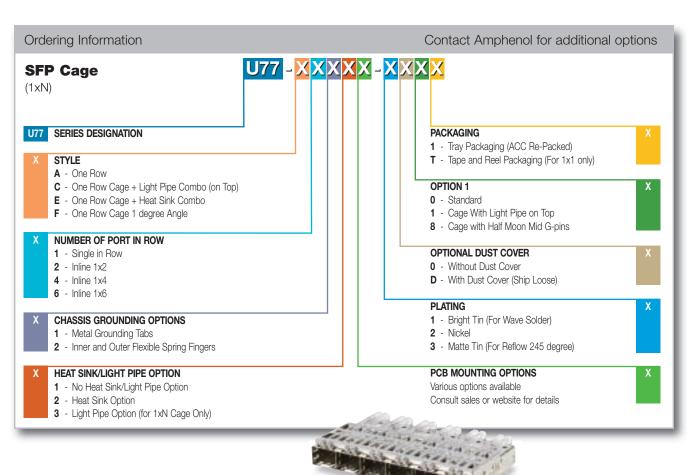


SFP 1xN Cages & Connectors





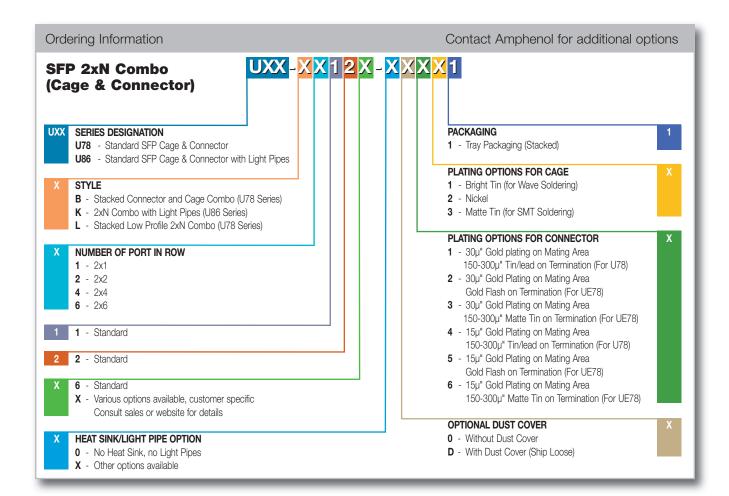




1x6 SFP cage with light pipes U77-C6114-2011

SFP 2xN Cage & Connector Combos







2x1 SFP Combo (Customized Version) U78-B112C-00121



2x4 SFP Combo U78-B4127-00121

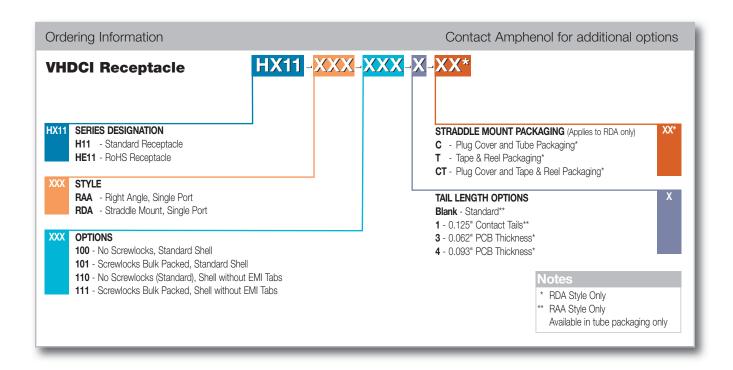


2x2 SFP Combo



VHDCI Receptacle

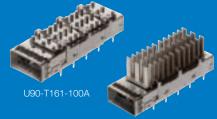
Very High Density Cable interconnect (VHDCI) provides interconnections where space limitations exist and high performance is a key requirement. Designed to be compact, these fully shielded connectors support ESD/EMI protection and are capable of transferring data up to 80 Gbps while meeting EI700A0AF specifications. Receptacles are available in both right-angle and straddle-mount versions with or without shielded EMI tabs.





ExpressPort™ QSFP+ **QSFP**





The ExpressPortTM QSFP+/QSFP Interconnect system is comprised of a 38-position 0.8 mm pitch SMT connector and a press-fit cage designed to comply with the Quad Small Form-factor Pluggable (QSFP) Transceiver Specifications. The connector system is capable of data rates beyond 10 Gbps per channel (4 channels) and is intended for external connections (38-position connector). High speed serial interconnect applications include clusters, servers and storage devices.

The ExpressPort™ QSFP+ E-series connector family is rated at 28 Gbps per channel (4x28), featuring a stamped and formed contact design providing improved mechanical durability. This connector features an integrated grounding structure and resonance dampening features for superior crosstalk performance. The contact design is optimized for a smooth impedance profile resulting in low losses. The ExpressPort ™ QSFP+ E-series connector is designed for IBTA [EDR] applications (25.78 Gbps) and is fully compatible with industry standard SFF-8436 QSFP+ modules. The QSFP+ E-series connector is fully compatible with existing QSFP and QSFP+ cages.

Specification Highlights

The QSFP interconnect system is comprised of a press-fit cage assembly which is used with 38-position, 0.8 mm pitch connectors complying with QSFP Transceiver Specifications.

Mechanical Characteristics

- · Cage is keyed according to QSFP MSA
- Durability: 250 mating cycles minimum
- Connector insertion force: 40 N max
- · Connector withdrawal force: 30 N max

Electrical Characteristics

- Operating voltage: 30 V
 - Operating current: 0.5 A
- Insulation resistance: 1000 M Ω min DWV: 300 V AC
- Contact resistance: 70 mΩ max Hot swappable
- Differential impedance: 100 Ω +/- 10 Ω

Signal Integrity Characteristics

QSFP. ExpressPort™ QSFP+

- Return Loss: 10 dB
- Near end isolation: -40 dB (frequencies up to 3 GHz)
- Insertion loss: 0.13dB max (frequencies up to 1.25 GHz) 0.25 dB max (frequencies 1.25 - 2.50 GHz) 0.25 dB max (frequencies 2.50 - 5.00 GHz)
- Rise time for impedance measurement: 25 ps
- Within pair skew: 1 ps
- NEXT: ≤ 2%

ExpressPort™ QSFP+ E-series Connector

- Return loss: -12dB max (frequencies up to 14GHz)
- Insertion loss: 1.4dB max (frequencies up to 14GHz)
- Common mode conversion: -24dB max (up to 14 GHz)
- Integrated Crosstalk Noise: 3mV rms
 - assumes 3 nearest-neighbor (most-detrimental) aggressor parameters and receiver parameters:
 - Near- & far-end aggressors' peak differential amplitude: 600mv
 - Near- & far-end aggressors' 20%-80% risetime: 9.6ps
 - 3dB reference receiver bandwidth: 18.75 GHz
 - Range of integration: 10MHz to 28 GHz
 - MDNEXT: 1mVrms MDFEXT: 2.8mVrms

Packaging

- Tape and reel packaging: connector or 1x1 cage
- Tray packaging: cage of all sizes
- · Bulk packaging: dust cover

Materials

- Cage
 - Base material: copper alloy
 - Plating: nickel
 - Light pipe: optical grade polycarbonate
 - · Heat sink: aluminum allov
 - · Heat sink clip: stainless steel
 - Dust cover: thermoplastic
- Connector
 - Contact base material: copper alloy
 - Contact plating: gold on mating area; matte tin on terminations and grounding tabs
 - Housings: glass reinforced, lead-free solder reflow process compatible thermoplastic, UL94V-0 rated

Temperature Rating

- Operating temperature: -40 °C to +85 °C
- Storage temperature: -40 °C to +85 °C

Configurations (Rows x Ports per row)

• 1x1

1x4

• 1x6

Options

- Cage design
 - Through the bezel
 - Behind the bezel
- Heat sinks
- Light pipe
 - Round 1.4 mm
 - Square 2.6x2.6 mm
- Dust cover

1x3 QSFP Cage with Heat Sink and Round Light Pipes U90-G351-101A

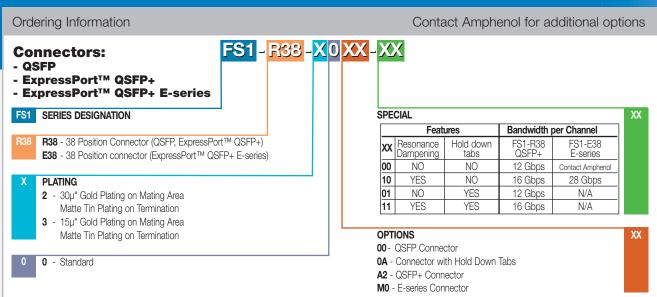


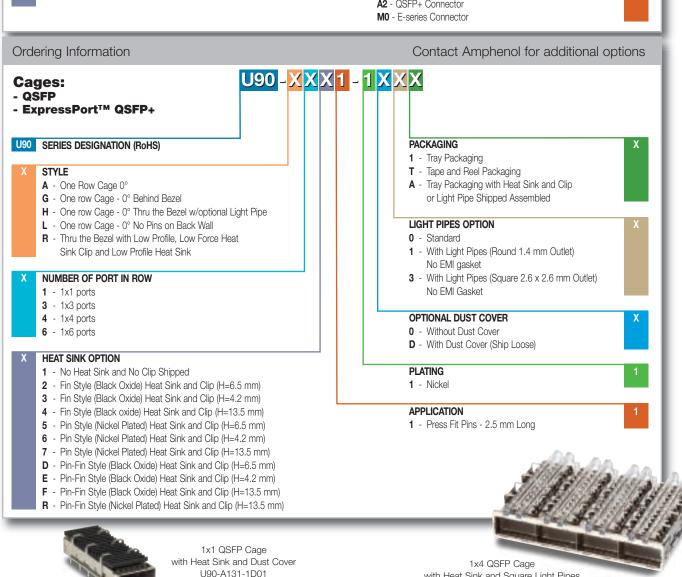




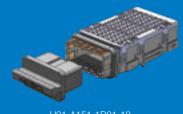








with Heat Sink and Square Light Pipes U90-G461-103A



The CXP cage and connector system is one of Amphenol's newest additions to the High Speed I/O Family. Amphenol's CXP connector comes in a one-piece press-fit assembly system with twelve channels of 10 Gbps data rates, resulting in 120 Gbps of total bandwidth - the fastest and most dense I/O on the market today. It also enables pluggable copper or optical cables to increase the flexibility of system-level hardware for end users. CXP is ideal for network switches, routers, servers, and storage devices.

Specification Highlights

The CXP interconnect system is comprised of an 84-position, 2-row press-fit connector and a cage assembly as one unit complying with SFF-8642.

General Characteristics

- RoHS compliant
- Industry standard footprint
- Industry standard EIA-364

Mechanical Characteristics

- Insertion force for an MSA compliant transceiver: 150 N max
- Unmating force: 50 N max
- Durability: 250 mating cycles minimum

Electrical Characteristics

- Hot swappable
- Operating voltage: 30 V
- Operating current: 0.5 A
- Differential impedance: 100 Ω +/- 10 Ω
- DWV: 300 V AC
- Insulation resistance: 1000 M Ω min

Packaging

- Tray packaging: cage and connector assembly
- · Bulk packaging: dust cover

Temperature Rating

- Operating temperature: -40 °C to +85 °C
- Storage temperature: -55 °C to +105 °C

Materials

- Cage
 - Base material: zinc alloy
 - · Plating: nickel
 - Heat sink: aluminum alloy
 - · Heat sink clip: stainless steel
 - · Cage cover: stainless steel
 - Mounting screw: AISI 1010 steel
 - Dust cover: thermoplastic
- Connector
 - Contact base material: copper alloy
 - Contact plating: gold on mating area; tin-lead on termination
 - Housings: glass reinforced, lead-free solder reflow process compatible thermoplastic, UL94V-0 rated

Configurations

- 1x1
- Custom solutions available

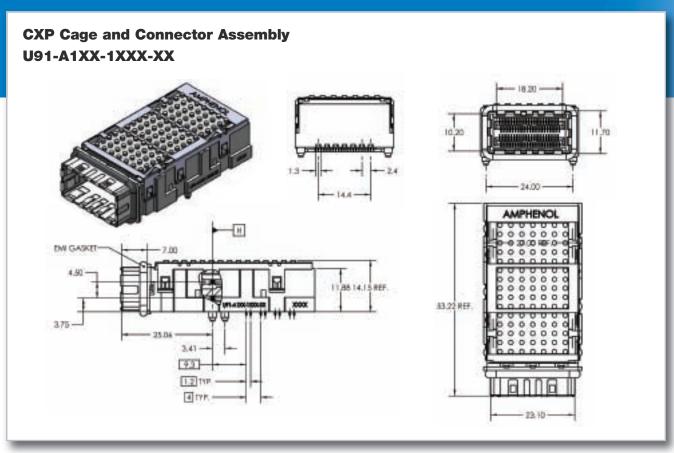
Options

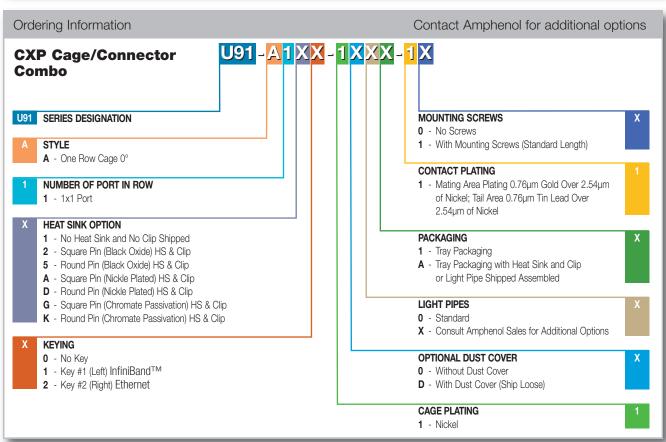
- Heat sink
- Dust cover
- EMI shielding
 - · Conductive elastomeric gasket
 - · Metal spring fingers
- - Key #1 (Left) InfiniBand™
 - · Key #2 (Right) Ethernet





CXP Cage and Connector Assembly U91-A121-100A-10





Mini-SAS FS Series





ES2-SE1-12C1

FS1-S02-14F2-LF

The Mini-SAS external I/O connector system consists of a die-cast metal cage and a Compact MultiLane SMT Connector, featuring proven "cut edge" style contacts. Providing 4 serial send/receive channels per port, this connector system is designed to satisfy the needs for gigabit serial data transmission applications with signal speeds across the connector interface of 6 Gbps per channel.

The cage is mounted separately to the body so that the stress imposed by insertion and removal of the cable plug does not affect the signal/body solder joints. The connector is available with unique solder hold-down tabs designed to provide additional mechanical robustness in demanding applications.

Specification Highlights

The Mini-SAS interconnect system is comprised of a cage assembly which is used with 26-position, 0.8 mm pitch connectors complying with SFF-8086, SFF-8087 and SFF-8088.

Mechanical Characteristics

- Co-planarity specification: 0.1 mm
- Connector insertion force: 55.5 N max
- Connector withdrawal force: 49.0 N max
- Durability: 250 mating cycles minimum
- Reverse keying for active copper cables per SAS 2.0

Electrical Characteristics

- · Operating voltage: 30 V
- Operating current: 0.5 A
- Differential impedance: 100 Ω +/- 10 Ω
- DWV: 300V AC
- Insulation resistance: 1000 M Ω min
- Contact resistance: 80 m Ω max
- Near end isolation: -40 dB (frequencies up to 3 GHz)
- Insertion loss: 1.0 dB maximum (frequencies up to 1.6 GHz)
- Rise time for impedance measurement: 50 ps
- · Within pair skew: 5 ps

Configurations (Rows x Ports per row)

- 1x1
- 1x2
- 1x4

Packaging

- Tape and reel packaging: connector
- Tray packaging: cage
- · Bulk packaging: mounting screw or dust cover

Materials

- Cage
 - Base material: zinc alloy
 - Plating: nickel
 - Mounting screw: AISI 1010 steel
 - Light pipe: optical grade polycarbonate
 - Dust cover: thermoplastic
- Connector
 - Contact base material: copper alloy
 - Contact plating: gold on mating area; matte tin on termination
 - Housings: glass reinforced, lead-free solder reflow process compatible thermoplastic, UL94V-0 rated

Temperature Rating

- Operating temperature: -55 °C to +85 °C
- Storage temperature: -55 °C to +85 °C

Options

- · Cage inclination from printed circuit board
 - 0° angle
 - 1° angle (PCI applications)
- Keying
- Dust cover
- Light pipe
- EMI shielding
 - · Conductive elastomeric gasket
 - · Soft shield foam gasket
 - · Stainless steel gasket



1x2 Mini-SAS 2.0 Cage with Foam Gasket FS2-S02-14F1



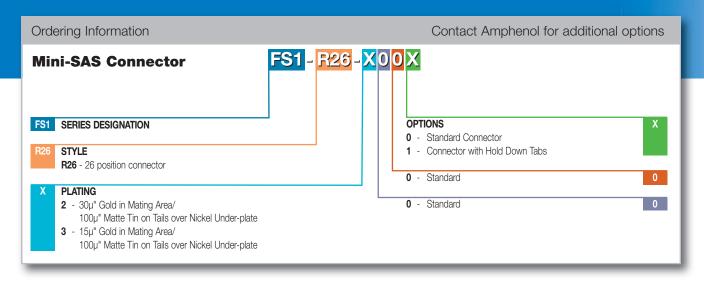


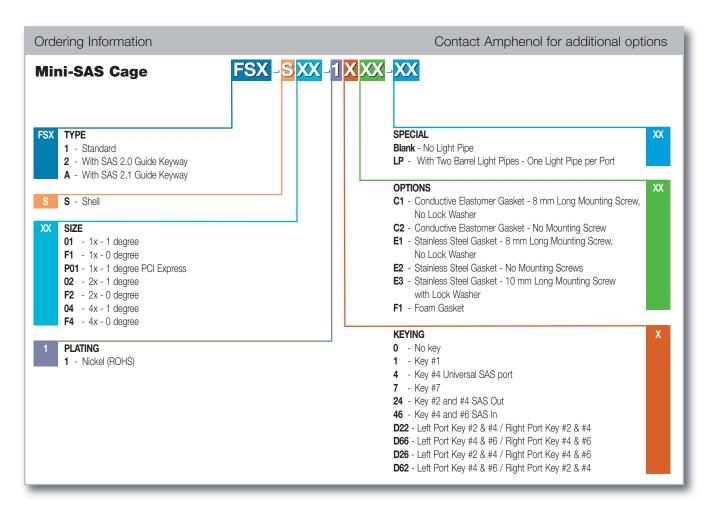
1x2 Mini-SAS 2.0 Cage with Elastomeric Gasket FS2-SF2-16C1



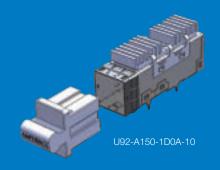








Mini-SAS HD U92 Series



Amphenol's Mini-SAS High Density interconnect is the next generation SAS system, with 4x and 16x cable-plugging options to provide faster data transmission and more bandwidth for end users. The Mini-SAS HD connector system has a two-row, right-angle connector with 12 Gbps per channel. Each connector handles 4 lanes of data for up to 48 Gbps of total bandwidth. Ganged options are also available up to a 1x4 configuration for up to 192 Gbps of total bandwidth. This connector will mate with active copper and optical cable assemblies and active pluggable modules for extended-length applications in data centers. Main applications for Mini-SAS HD include HBA Servers, storage devices, switches and rack-mounted computers.

Specification Highlights

The Mini-SAS HD interconnect system is comprised of a 36-position, 2-row, press-fit connector and stamped and formed cage assembly as one unit complying with SFF-8644.

General Characteristics

- RoHS compliant
- · Industry standard footprint
- Industry standard EIA-364

Mechanical Characteristics

• Durability: 250 mating cycles minimum

Electrical Characteristics

- Hot swappable
- Operating voltage: 30 V
- Operating current: 0.5 A
- Differential impedance: 100 Ω +/- 10 Ω
- DWV: 300 V AC
- Insulation resistance: 1000 M Ω min
- EMI spring fingers for superior EMI performance

Packaging

- Tray packaging: cage and connector assembly
- Bulk packaging: dust cover or mounting screw

Configurations (Rows x Ports per row)

- 1x1
- 1x2
- 1

Materials

- Cage
 - Base material: copper alloy
 - · Plating: nickel
 - Heat sink: aluminum alloy
 - Heat sink clip: stainless steel
 - Dust cover: thermoplastic
 - Mounting screw: AISI 1010 steel
 - EMI spring finger: copper alloy with nickel plating
- Connector
 - Contact base material: copper alloy
 - Contact plating: gold on mating area; tin-lead on termination
 - Housings: glass reinforced, lead-free solder reflow process compatible thermoplastic, UL94V-0 rated

Temperature Rating

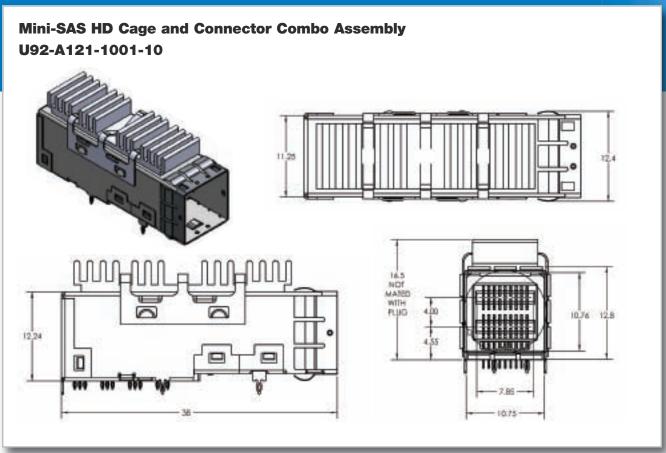
- Operating temperature: -40 °C to +85 °C
- Storage temperature: -55 °C to +105 °C

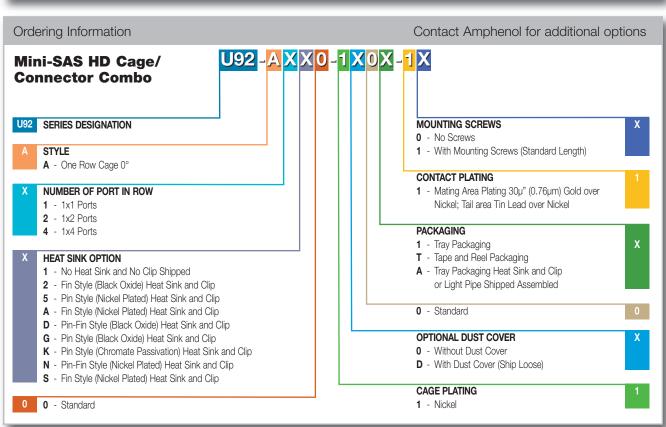
Options

- Heat sink
- Dust cover



1x4 Mini-SAS HD Combo U92-A410-1001-20





Infinity Receptacle





U65-B04-1010T

Amphenol's INFINITY (4x/12x) series of connectors facilitate data speeds up to 60 Gbps total bandwidth, as required by InfiniBand™, Fibre Channel and Serial Attached SCSI Trade Associations, with superior EMI performance. INFINITY connectors are high-density, hot pluggable and meet SFF 8470 specifications.

A variety of receptacles are available that will fit multiple connectors into a 1U form factor and PCI bracket. All receptacles are available with standard or RoHS compliant materials. They are capable of data rates beyond 5.0 Gbps per channel. 4x and 12x versions of receptacles are available with lanyard latch or screw lock styles.

Specification Highlights

The Infinity interconnect system is comprised of a 0.8 mm pitch SMT receptacle complying with SFF-8470.

Mechanical Characteristics

- Co-planarity specification: 0.1 mm
- Connector insertion force: 55.5 N max (4x version)
- Connector withdrawal force: 6.1 N typical (4x version)
- Durability: 250 mating cycles minimum

Electrical Characteristics

- Differential impedance: 100 Ω +/- 10 Ω
- DWV: 300 V AC
- Insulation resistance: 10 G Ω min
- Contact resistance: 80 mΩ max
- Rise time for impedance measurement: 70 ps
- Within pair skew: 5 ps

Options

- Number of channels
- 4x 12x
- Mating style
 - Screw lock style
 - · Lanyard latch style
- Mounting style
 - Screw mount
 - Solder post
 - Extended arms

Materials

- Shell
 - · Base material: zinc alloy
 - Plating: nickel
 - · Rear cover: stainless steel
 - · Jack screw: steel with nickel plating
 - · Gasket: stainless steel
 - · Locking plate: stainless steel
- Connector
 - Contact base material: copper alloy
 - Contact plating: gold on mating area; tin or tin-lead on termination
 - Housings: glass reinforced, lead-free solder reflow process compatible thermoplastic, UL94V-0 rated

Temperature Rating

- Operating temperature: -40 °C to +85 °C
- Storage temperature: -40 °C to +85 °C

Packaging

- Tape and reel packaging
- Tray packaging



Lanyard latch with rear arms and solder posts U65-B04-40C0-T

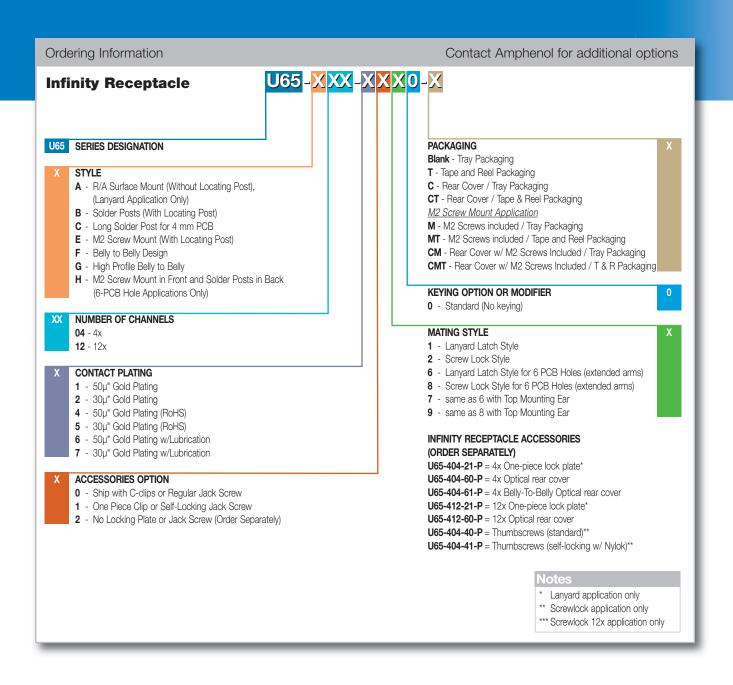


Lanyard latch with rear arms, screw mount U65-E04-2010



Lanyard latch with top mounting, rear arms U65-H04-40D0-T





ExpressPort™ XFP+ XFP



U79-A141-2D01

The XFP interconnect system is capable of a 10 Gbps data rate and is intended for external I/O connections. High speed serial interconnect applications include clusters, servers and storage devices. It is a smaller space and lower cost alternative to parallel-optics VSR. XFP also requires less than one-third the power and physical space of an MSA interconnect with parallel interface.

The Expressport[™] XFP+ Connector is designed to extend performance to 14 Gbps. Please consult Amphenol Factory for availability.

Specification Highlights

The XFP interconnect system is comprised of a press-fit cage assembly which is used with 30-position, 0.8 mm pitch SMT connectors complying with INF-8077i.

Mechanical Characteristics

- Insertion force: 40 N max (cage and connector)
- Withdrawal force: 30 N max (cage and connector)
- Cage retention: 180 N min (latch strength)
- Durability: 250 mating cycles minimum

Electrical Characteristics

- Operating voltage: 30 V
- Operating current: 0.5 A
- Differential impedance: 100 Ω +/- 5 Ω
- DWV: 300 V AC
- Insulation resistance: 1000 $\text{M}\Omega\,$ min
- Contact resistance: 70 m Ω max
- Near-end isolation: -40 dB
- Insertion loss: 1.0 dB max

Options

- Heat sink
- Dust cover
- EMI shielding
 - Conductive elastomeric gasket at back of cage
 - Mylar tape

Materials

- Cage
 - Base material: copper alloy
 - Plating: nickel
 - Front flange: zinc alloy
 - · Heat sink: aluminum alloy
 - Heat sink clip: stainless steel
 - Dust cover: thermoplastic
- Connector
 - Contact base material: copper alloy
 - Contact plating: gold on mating area; gold or matte tin on termination
 - Housings: glass reinforced, lead-free solder reflow process compatible thermoplastic, UL94V-0 rated

Temperature Rating

- Operating temperature: -40 °C to +85 °C
- Storage temperature: -40 °C to +85 °C

Packaging

- Tape and reel packaging: connector or cage
- Tray packaging: cage
- Bulk packaging: dust cover

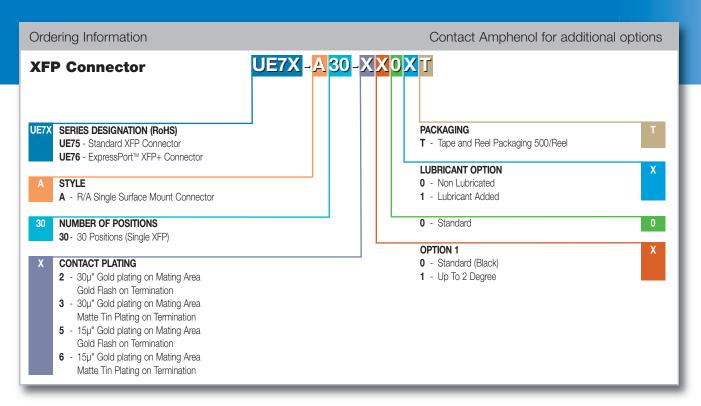


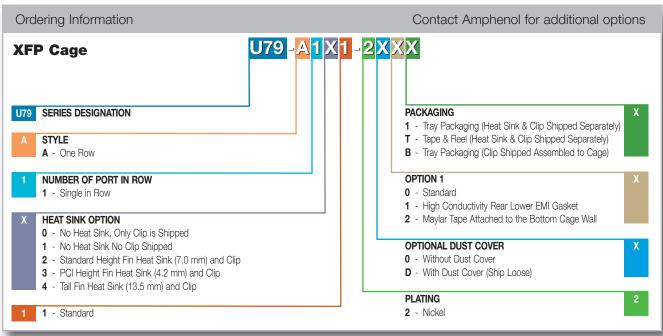
XFP Cage with 45° Fin Heat Sink U79-A1G1-2001



XFP Connector UE75-A30-3000T







HIGH SPEED I/O PRODUCTS

For more information about

ExpressPort™ SFP+, SFP, CXP, ExpressPort™ QSFP+,

ExpressPort™ QSFP+ E-Series, QSFP, Mini-SAS,

Mini-SAS HD, Infinity, VHDCI, ExpressPort™ XFP+, XFP

or other High Speed Products, please contact your local

Amphenol Sales representative, or contact:

North America

Phone: +1-416-291-4401 Fax: +1-416-292-0647

Email: sales@amphenolcanada.com www.amphenolacp.com

Europe

Phone: +31-30-635-8000 Fax: +31-30-637-7034

Email: customerservice@amphenol-nl.com

Asia

Phone: +852-2699-2663 Fax: +852-2691-1774

Email: enquiry@amphenol.com.hk

Amphenol World Headquarters Wallingford, CT, USA

Phone: 1-203-265-8900 Fax: 1-203-268-8516

Email: info@amphenolacp.com Web: www.amphenol.com



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